

SSCP80725GS6

High Frequency High Gain PNP Power BJT

Features

VCB	VCE	VEB	IC
-50V	-45V	-5V	-0.5A

Description

This device is produced with advanced high carrier density technology, which is especially used to minimize saturation voltage drop. This device particularly suits low voltage applications such as portable equipment, power management and other battery powered circuits, and low in-line power dissipation are needed in a very small outline surface mount package. Excellent thermal and electrical capabilities.

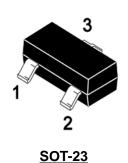
Applications

- Supply line switching circuits
- Battery management application
- DC/DC converter applications

Ordering Information

Device	Package	Shipping
SSCP80725GS6	SOT-23	3000/Reel

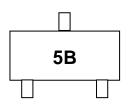
Pin configuration



1 - Base

Circuit Diagram

2 - Emitter



Marking (Top View)



ightharpoonup Absolute Maximum Ratings(T_A=25°C unless otherwise noted)

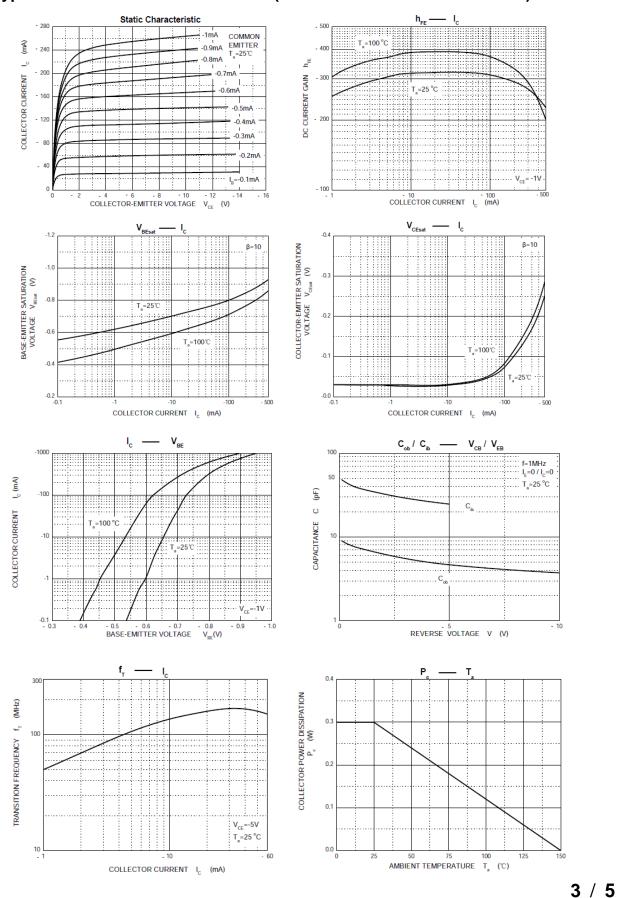
Parameter	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-50	V
Collector- Emitter Voltage	V _{CEO}	-45	V
Emitter-Base Voltage	V _{EBO}	-5	V
Collector Current-Continuous	Ic	-500	mA
Collector Power Dissipation	Pc	300	mW
Thermal resistance from junction to ambient	R _{0JA}	417	°C/W
Junction Temperature	TJ	150	$^{\circ}\! \mathbb{C}$
Storage Temperature	T _{STG}	-55 to 150	$^{\circ}$ C

\succ Electrical Characteristics (T_A=25°C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Collector-Base Breakdown Voltage	ВУсво	I _C =-10μΑ,I _E =0	-50			V
Collector-emitter Breakdown Voltage	BVceo	I _C =-10mA,I _B =0	-45			V
Emitter -Base Breakdown Voltage	BV _{EBO}	I _E =-1µA A,I _C =0	-5			V
Collector Cutoff Current	Ісво	V _{CB} =-45V,I _E =0			-0.1	μA
Emitter Cutoff Current	I _{EBO}	V _{EB} =-4V,I _C =0			-0.1	μA
DC Current Gain	hFE	V _{CE} =-1V,I _C =-100mA	160		400	
DC Current Gain		V _{CE} =-1V,I _C =-500mA	40			
Collector-Emitter Saturation Voltage	V _{CE(sat)}	I _C =-500mA,I _B =-50mA			-0.7	V
Base-Emitter Saturation Voltage	V _{BE(sat)}	I _C =-500mA,I _B =-50mA			-1.2	V
Base-emitter Voltage	V _{BE(ON)}	V _{CE} =1V,I _C =500mA			1.2	V
Transition frequency	f⊤	V _{CE} =-5V,I _C =-10mA f=100MHz	100			MHz

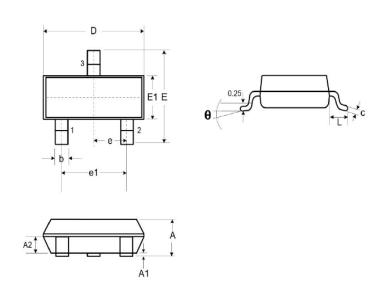


> Typical Performance Characteristics (T_A=25℃ unless otherwise noted)



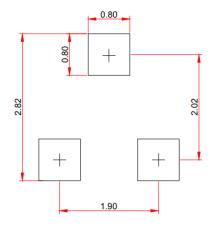


> Package Information



DIM	Millimeters			
	Min.	Тур.	Max.	
Α	0.89	ı	1.12	
A 1	0.01	ı	0.10	
A2	0.88	0.95	1.02	
b	0.30		0.51	
С	0.08	-	0.18	
D	2.80	2.90	3.04	
E	2.10	2.37	2.64	
E1	1.20	1.30	1.40	
е		0.95		
e1	1.90			
L	0.40	0.50	0.60	
L1	0.55			
N	3			
θ	0°	-	8°	

Recommended Pad outline (Unit: mm)





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